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MOSFET – Power, Single **N-Channel** 60 V, 3.0 mΩ, 133 A

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	$3.0~\mathrm{m}\Omega$ @ 10 V	133 A	
00 V	$4.2 \text{ m}\Omega @ 4.5 \text{ V}$	100 /	

NVMFS5C638NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C638NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Parameter Value Unit Symbol Drain-to-Source Voltage 60 V V_{DSS} Gate-to-Source Voltage V V_{GS} ±20 Continuous Drain $T_C = 25^{\circ}C$ I_D 133 A Current $R_{\theta JC}$ $T_{\rm C} = 100^{\circ}\overline{\rm C}$ 94 (Notes 1, 3) Steady State Power Dissipation $T_C = 25^{\circ}C$ P_D 100 W R_{0JC} (Note 1) $T_C = 100^{\circ}C$ 50 Continuous Drain $T_A = 25^{\circ}C$ 26 A I_{D} Current R_{0JA} $T_A = 100^{\circ}C$ 18 (Notes 1, 2, 3) Steady State Power Dissipation $T_A = 25^{\circ}C$ w P_D 4 R_{0,JA} (Notes 1 & 2) $T_A = 100^{\circ}C$ 2 **Pulsed Drain Current** 811 $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ I_{DM} А °C T_J, T_{stg} –55 to Operating Junction and Storage Temperature + 175 Source Current (Body Diode) I_S 84 А Single Pulse Drain-to-Source Avalanche 180 E_{AS} mJ Energy $(I_{L(pk)} = 13 \text{ A})$ Lead Temperature for Soldering Purposes °C T_L 260 (1/8" from case for 10 s)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

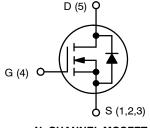
THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.5	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40.1	

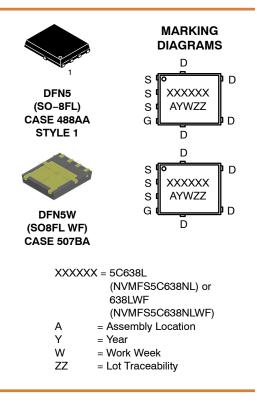
The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.







ORDERING INFORMATION

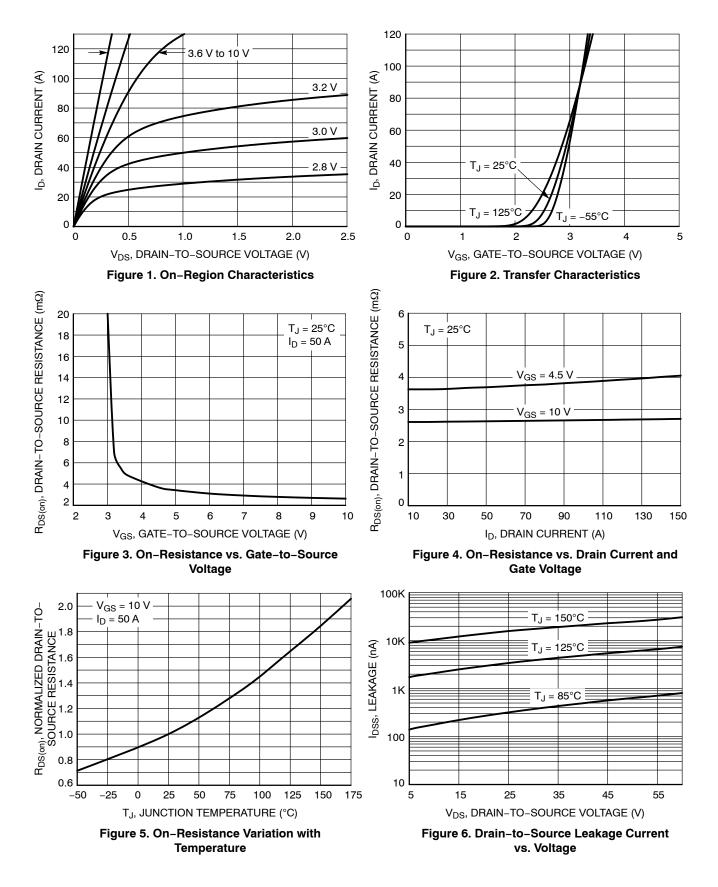
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

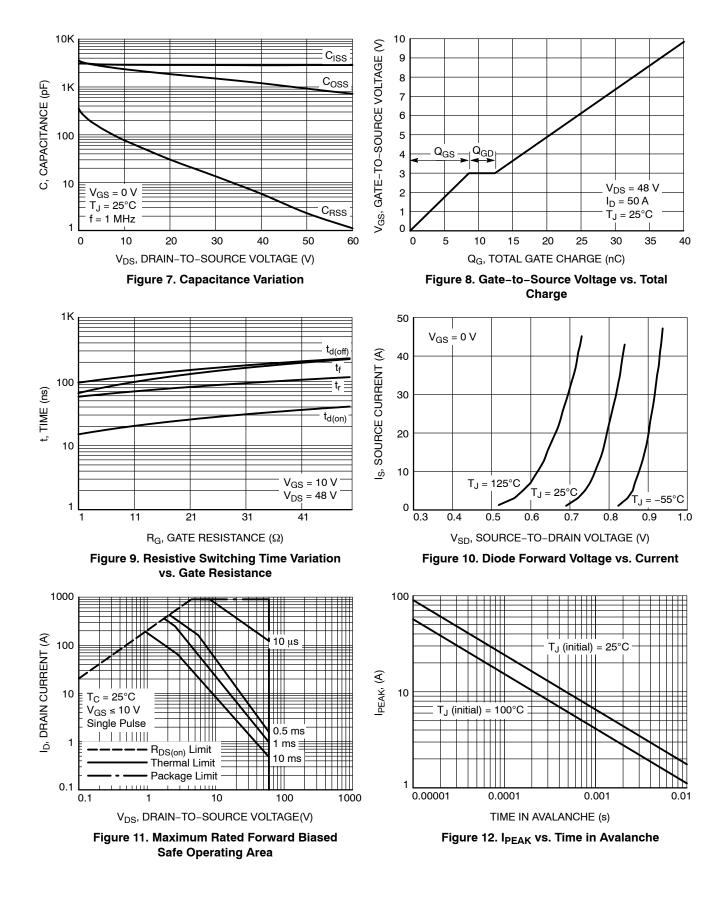
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				<u> </u>		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J		-		26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	
		V _{DS} = 60 V	T _J = 125°C			250	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	₆ = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250 μA		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		2.6	3.0	
		V _{GS} = 4.5 V	I _D = 50 A		3.6	4.2	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D) = 50 A		130		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			2880		pF
Output Capacitance	C _{OSS}				1680		
Reverse Transfer Capacitance	C _{RSS}				22		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 50 A			18.4		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 50 A			40.7		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 50 A			4.5		
Gate-to-Source Charge	Q _{GS}				8.6		nC
Gate-to-Drain Charge	Q _{GD}				3.8		
Plateau Voltage	V _{GP}				3.0		V
SWITCHING CHARACTERISTICS (Note 5))						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 48 V, I _D = 50 A, R _G = 1 Ω			15		
Rise Time	tr				58		ns
Turn–Off Delay Time	t _{d(OFF)}				66		
Fall Time	t _f				96		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.84	1.2	
		$I_{\rm S} = 50 \rm{A}$	T _J = 125°C		0.73		V
Reverse Recovery Time	t _{RR}		•		42		
Charge Time	t _a	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 50 A			21		ns
Discharge Time	t _b				22		
Reverse Recovery Charge	Q _{RR}				28		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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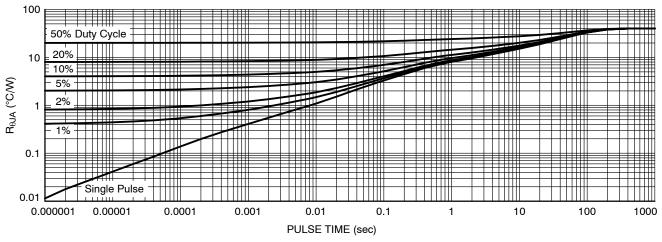


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

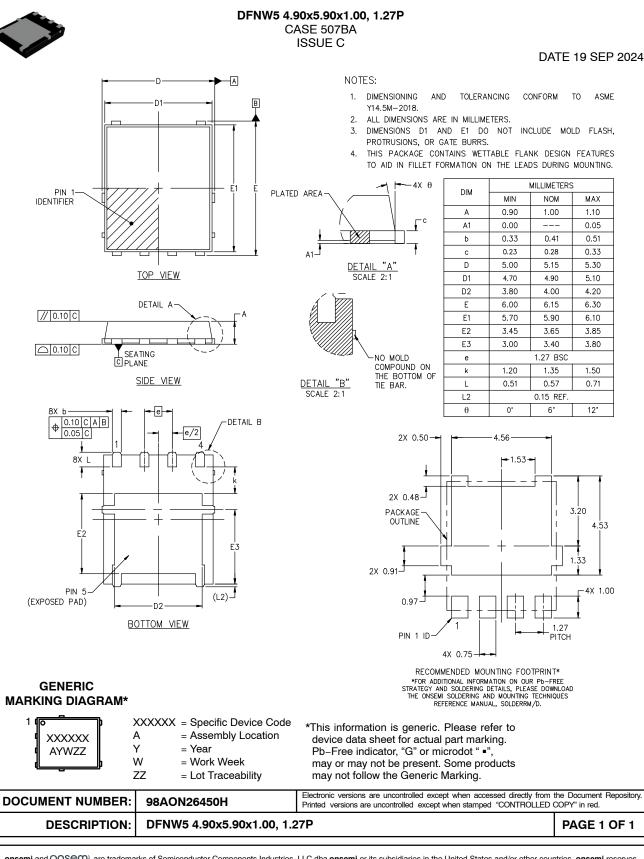
Device	Marking	Package	Shipping [†]
NVMFS5C638NLT1G	5C638L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C638NLWFT1G	638LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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